

Part Number: AA5060SEC/E

Hyper Orange

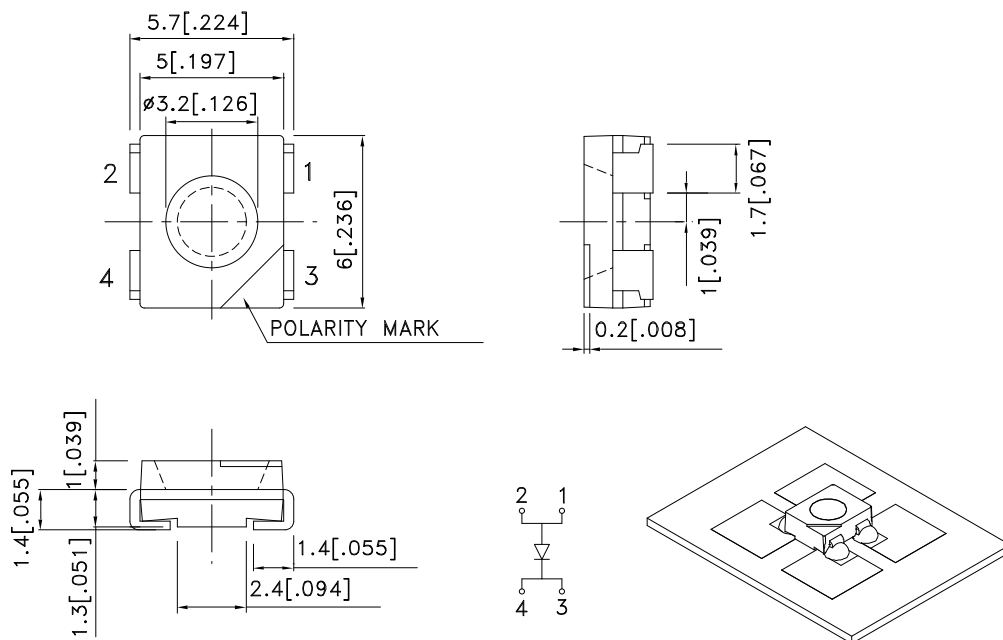
Features

- Single color.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Ideal for backlighting.
- Package : 500pcs / reel.
- Moisture sensitivity level : level 4.
- RoHS compliant.

Description

The Hyper Orange source color devices are made with InGaAlP on GaAs substrate Light Emitting Diode.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
3. Specifications are subject to change without notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.



Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 50mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
AA5060SEC/E	Hyper Orange (InGaAlP)	WATER CLEAR	650	1000	100°

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Orange	630		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Orange	621		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Orange	20		nm	IF=20mA
C	Capacitance	Hyper Orange	25		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Orange	2	2.5	V	IF=20mA
IR	Reverse Current	Hyper Orange		10	uA	VR=5V

Notes:

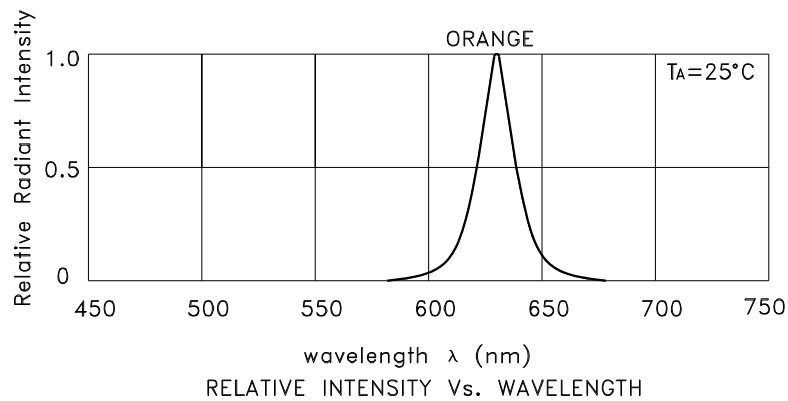
- 1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Orange	Units
Power dissipation	125	mW
DC Forward Current	50	mA
Peak Forward Current [1]	195	mA
Reverse Voltage	5	V
Operating Temperature	-40°C To +85°C	
Storage Temperature	-40°C To +85°C	

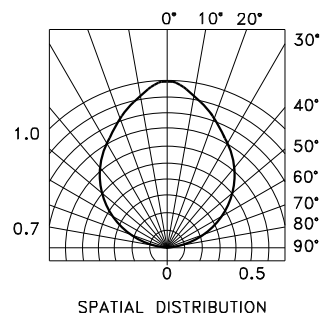
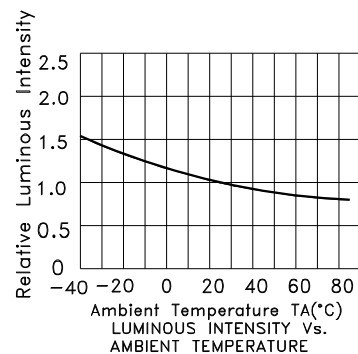
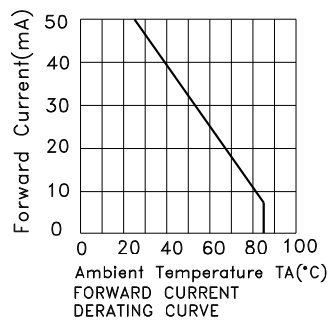
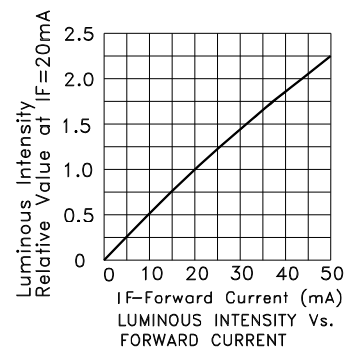
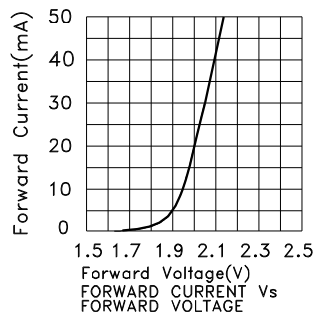
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



Hyper Orange

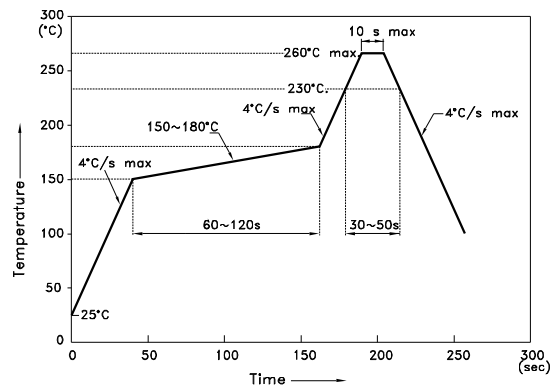
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Reflow soldering is recommended and the soldering profile is shown below.
Other soldering methods are not recommended as they might cause damage to the product.

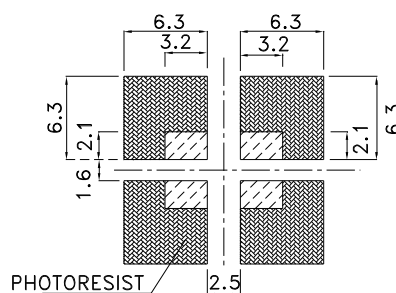
Reflow Soldering Profile For Lead-free SMT Process.



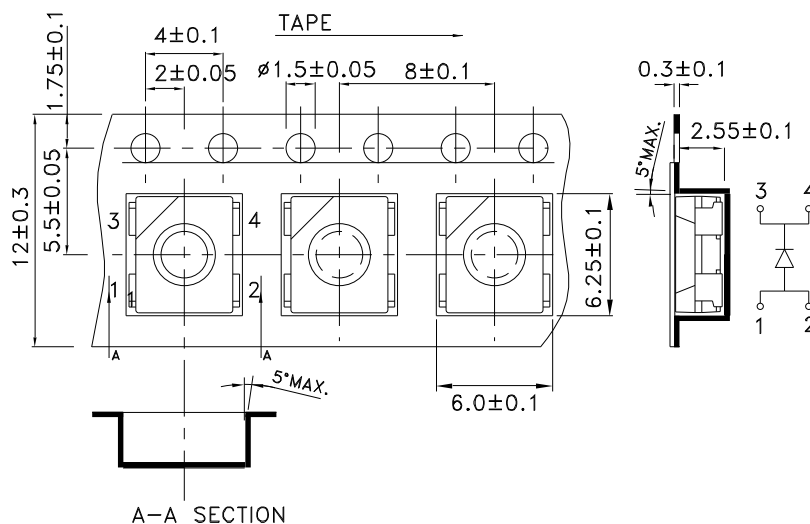
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

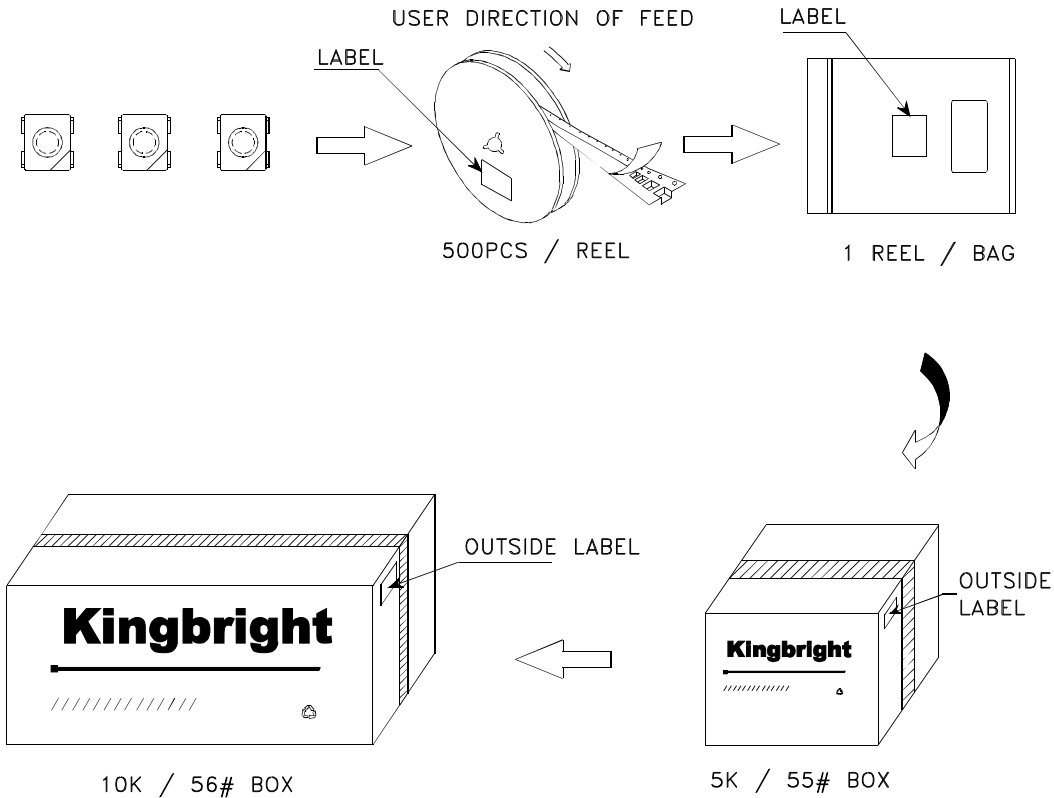



Tape Dimensions (Units : mm)



PACKING & LABEL SPECIFICATIONS

AA5060SEC/E



Kingbright		
P/NO: AA5060xxx		
QTY: 500 pcs	Q.C.	<div>Q C XX XX XXXX PASSED</div>
S/N: XXXX		
CODE: XXX		
LOT NO:		
 XXXXXXXXXXXXXXXXXXXXXXXXXXXX		
RoHS Compliant		